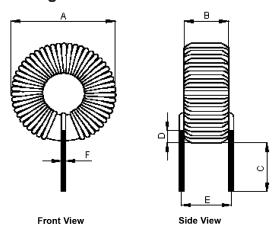
# Inductor

# multicomp PRO

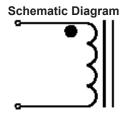


### **Configurations and Dimensions**



Α	12mm (Max.)
В	5.5mm (Max.)
С	15 ±2mm
D	1mm (Min.)
Е	4.5 ±2mm
F	Ø0.4mm (Ref.)

### RoHS Compliant



#### Note:

- 1. Wire UEFN/U (155°C) Ø0.4mm
- 2. 50TS (Reference) C.W

### **Test Data for Mechanical**

Test Item	A mm	B mm	C mm	D mm	E mm	F mm
Specification	12 (Max.)	5.5 (Max.)	15 ±2	1 (Min.)	4.5 ±2	Ø0.4 (Ref.)
1	10.6	4.68	14.78	1.38	4.42	0.38
2	10.61	4.67	15.23	1.32	4.31	
3	10.64	4.63	14.79	1.41	4.33	0.39
4	10.69	4.62	15.03	1.33	4.36	
5	10.67	4.61	14.98	1.32	4.37	0.37
Average	10.64	4.64	14.96	1.35	4.36	0.38

#### **Electrical Characteristics**

Test Condition		
10kHz / 5mA	L	68μH ±20%
TA = 25°C	DCR	100mΩ (Max.)
10kHz / 5mA Irms = 0.8A	ΔΤ	Temperature rise 40°C (Max.)

Operating temperature : -55°C to +130°C

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# **Inductor**



### **Reliability Test**

Test Item	Specifications		Test Method and Remarks	
Operating temperature range	-55°C to +130°C		Including temperature r	rise due to self-generated heat.
Storage condition	Ambient temperature Humidity	: 0°C to 40°C : Below 70% RH	To maintain the solderability of terminal electrodes, care must be taken to control temperature and humidity in th storage area.	
Moisture sensitivity	Appearance  DCR change Inductance change	: No abnormality No damage : Within ±5% : Within ±5%	According to J-STD-02 Test condition Test duration Recovery	0B level 3 : 60°C 60% RH : 40 hrs : 1 to 2 hours of recovery under the standard condition after the removal from the test chamber.
Solderability	All termination shall exhibit a continuous solder coating free from defects for a minimum of 95% of the surface area of any individual lead.		According to J-STD-00 Steam aging category Steam aging duration Solder Solder temperature Dip time	2B : 97°C 98% RH : 8 hrs : Lead-free solder : 260 ±5°C : 5 +0 / -0.5s

### **Material List**

No.	Item	Material Description
1	Core	T37-75-TAF200 (Red / White)
2	Wire	Ø0.4 mm UEFN/U (155°C)
3	Solder (Lead-free)	Sn99.3% / Cu0.7%

### **Test Data for Electrical**

Test Item	L µH	DCR mΩ	ΔΤ
Condition	10kHz / 5mA	T <sub>A</sub> = 25°C	10kHz / 5mA Irms = 0.8A
Specification	68 ±20%	100 (Max.)	Temperature rise 40°C (Max.)
1	67.23	90.34	
2	67.38	91.25	
3	68.37	90.47	OK
4	67.79	90.68	
5	67.58	90.69	
Average	67.67	90.69	ОК

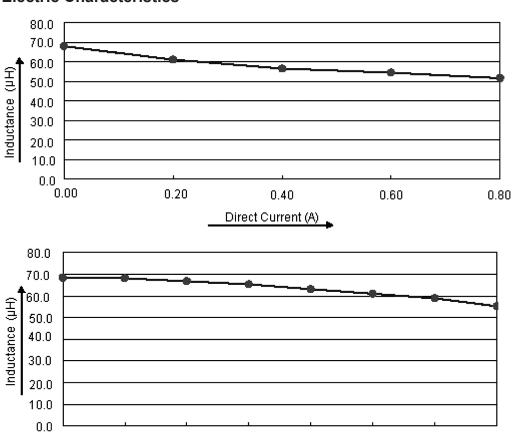
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## Inductor



### **Electric Characteristics**



200

400

Frequency (KHz)

#### **Part Number Table**

600

800

Description	Part Number
Inductor, 68µH, 20%, 2 Pin	MCAP103726044A-680MU

1000

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